



## Description

The TD101X series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a silicon planar phototransistor detector in a plastic LSO package with the robust coplanar double mold structure. TD101X series provide the most stable isolation feature.

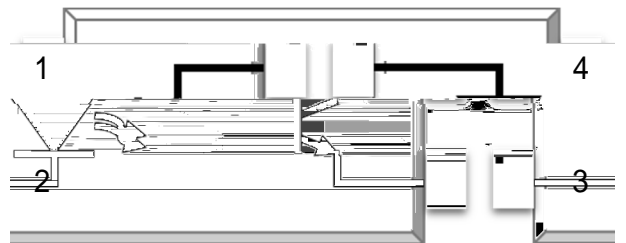
## Features

- High isolation (000) \* +S
- Temperature flexibility available see order information
- D, input with transistor output
- Operating temperature range . ( / , to 110 / ,
- $I_{SO} \leq 1A$ , , compliance
- +SL class 1
- Regulatory Approvals
  - 2L . 2L1(33)
  - )D1 . 14503!3.(. (6)D1077!. (8
  - , 9 , : G ; !< !=#1% G ; 77<7

## Applications

- Switch mode power supplies
- Programmable controllers
- Household appliances
- Office equipment

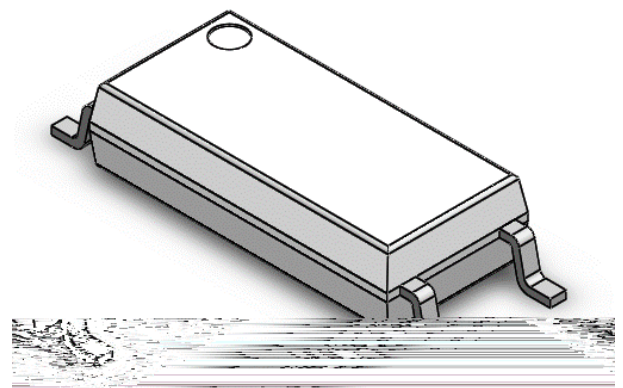
## SCHEMATIC



## PIN DEFINITION

1. Anode
2. Cathode
3. Emitter
4. Collector

## PACKAGE OUTLINE





A ' SO# " TE MA ( IM " M ) ATIN ! S				
A * A + 1 T 1 *	S @ + ; OL	) AL 2 1	2 4 AT	4 OT 1
A 4 2 T				
Borward , urrent	A <sub>B</sub>	50	mA	
ea" Borward , urrent	A <sub>B</sub>	1	A	1
* e&erse ) oltage	) *	5	)	
Anput ower Dissipation	A	100	m\$	
O 2 T 2 T				
, ollector . 1 mitter ) oltage	) , 1 0	70	)	
1 mitter . , ollector ) oltage	) 1 , 0	3	)	
, ollector , urrent	A ,	( 0	mA	
Output ower Dissipation	o	1 ( 0	m\$	
, O + + O 4				
Total ower Dissipation	tot	? ( 0	m\$	
Asolation ) oltage	) iso	( 000	) rms	?
Operating Temperature	Topr	. ( ( C 1 1 0	/ ,	
Storage Temperature	Tstg	. ( ( C 1 ? (	/ ,	
Soldering Temperature	Tsol	? 50	/ ,	

Note 1. 100µs pulse, 100Hz frequency

Note 2. AC For 1 Minute, R.H. = 40 ~ 60%



ELECTRICAL CHARACTERISTICS at Ta=25°C							
Symbol	Unit	Min	Typ	Max	Test Conditions	Notes	Ref
Forward Voltage	V <sub>F</sub>	-	1.5	-	I <sub>F</sub> = 10 mA, I <sub>R</sub> = 0		
Reverse Current	I <sub>R</sub>	-	10	-	V <sub>R</sub> = 5 V, I <sub>F</sub> = 0		
Input Capacitance	C <sub>in</sub>	-	0	-	f = 1 MHz, V <sub>R</sub> = 0 V		
Collector Current	I <sub>C</sub>	-	100	-	V <sub>CE</sub> = 5 V, I <sub>B</sub> = 10 mA		
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	-	0.7	-	I <sub>C</sub> = 10 mA, I <sub>B</sub> = 10 mA		
Collector-Emitter Voltage	V <sub>CE</sub>	-	3	-	I <sub>C</sub> = 10 mA, I <sub>B</sub> = 10 mA		
Transfer Ratio	h <sub>FE</sub>	-	50	-	I <sub>C</sub> = 10 mA, I <sub>B</sub> = 1 mA		
Transfer Ratio	h <sub>FE</sub>	-	5	-	I <sub>C</sub> = 10 mA, I <sub>B</sub> = 1 mA		
Transfer Ratio	h <sub>FE</sub>	-	100	-	I <sub>C</sub> = 10 mA, I <sub>B</sub> = 1 mA		
Transfer Ratio	h <sub>FE</sub>	-	150	-	I <sub>C</sub> = 10 mA, I <sub>B</sub> = 1 mA		
Transfer Ratio	h <sub>FE</sub>	-	?	-	I <sub>C</sub> = 10 mA, I <sub>B</sub> = 1 mA		
Transfer Ratio	h <sub>FE</sub>	-	?	-	I <sub>C</sub> = 10 mA, I <sub>B</sub> = 1 mA		
Transfer Ratio	h <sub>FE</sub>	-	?	-	I <sub>C</sub> = 10 mA, I <sub>B</sub> = 1 mA		
Transfer Ratio	h <sub>FE</sub>	-	?	-	I <sub>C</sub> = 10 mA, I <sub>B</sub> = 1 mA		
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	-	0.1	-	I <sub>C</sub> = 10 mA, I <sub>B</sub> = 10 mA		
Isolation Resistance	R <sub>ISO</sub>	10 <sup>11</sup>	10 <sup>11</sup>	-	V <sub>R</sub> = 50 V, I <sub>C</sub> = 0		
Bloating Capacitance	C <sub>BO</sub>	-	0	-	f = 1 MHz, V <sub>R</sub> = 0 V		
Cutoff Frequency	f <sub>c</sub>	-	70	-	V <sub>R</sub> = 0 V, I <sub>C</sub> = 10 mA		
Response Time (t <sub>rise</sub> )	T <sub>r</sub>	-	17	-	V <sub>R</sub> = 0 V, I <sub>C</sub> = 10 mA		
Response Time (t <sub>fall</sub> )	T <sub>f</sub>	-	5	-	V <sub>R</sub> = 0 V, I <sub>C</sub> = 10 mA		

Note 3. Fig.12&13

Note 4. Fig.14



**CHA ) ACTE ) ISTIC C " ) - ES**

<p>Fi..1 For /ard C&amp;rrent <b>0\$. Am1ient Tem%erat&amp;re</b></p>	<p>Fi..2 Collector Po /er Di\$\$i%ation <b>0\$. Am1ient Tem%erat&amp;re</b></p>
<p>Fi..3 For /ard C&amp;rrent <b>0\$. For /ard -olta .e</b></p>	<p>Fi..4 Collector Dar2 C&amp;rrent <b>0\$. Am1ient Tem%erat&amp;re</b></p>

Fi..+ Collector C&rrent  
**0\$. Collector3emitter -olta .e**

Fi..4 Collector C&rrent



CHARACTERISTIC CURVES

Fig. 5 Normalized Current Transfer Ratio vs. Base Current

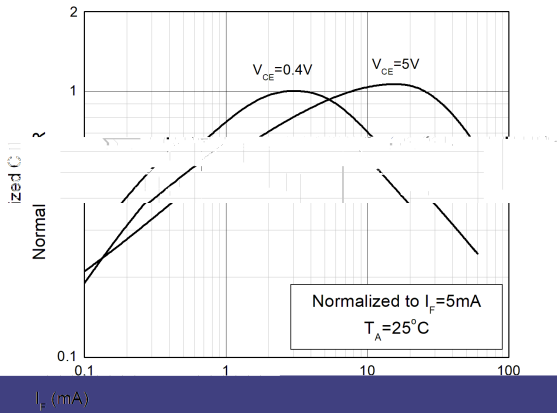


Fig. 8 Normalized Current Transfer Ratio vs. Ambient Temperature

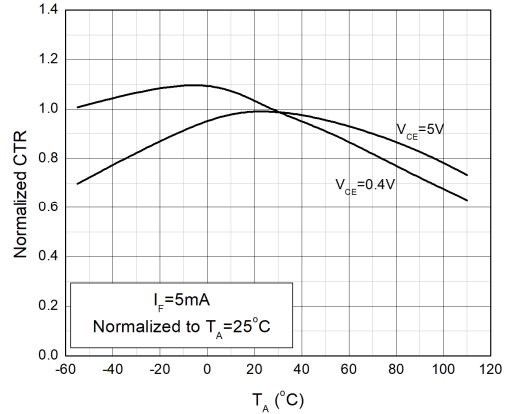


Fig. 9 Collector-Emitter Saturation Voltage vs. Ambient Temperature

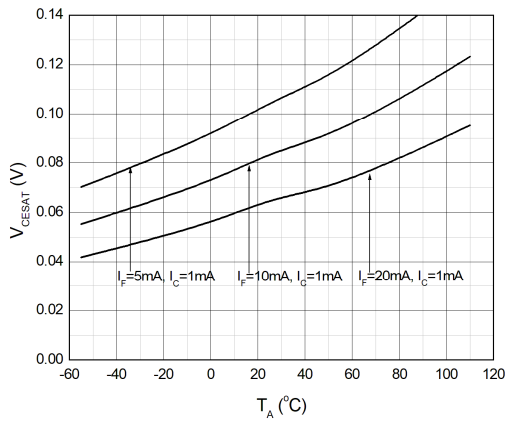


Fig. 10 Switching Time vs. Load Resistance

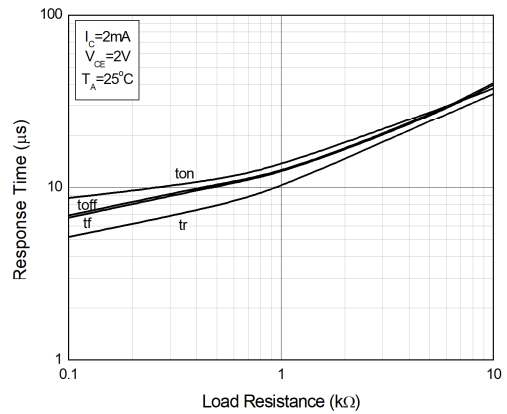
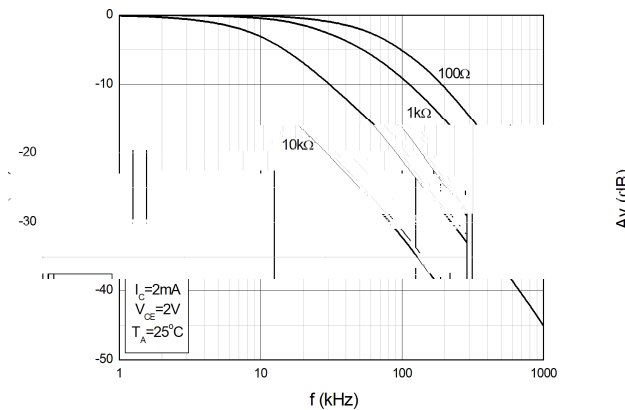


Fig. 11 Frequency Response



TEST CIRCUITS

Fig. 12 Test Circuit of Rise Time

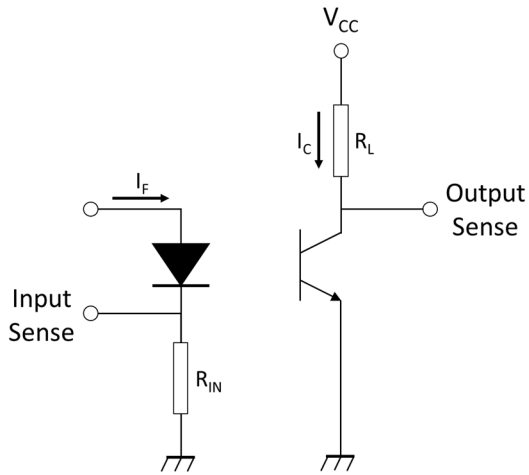


Fig. 13 Characteristic of Rise Time

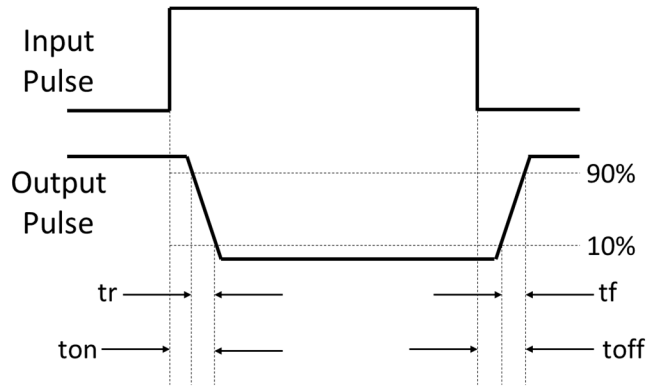
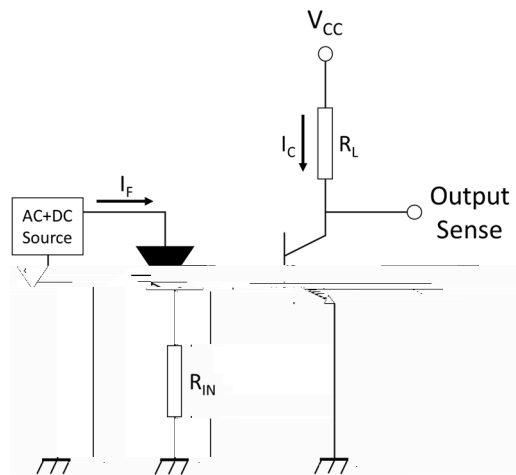
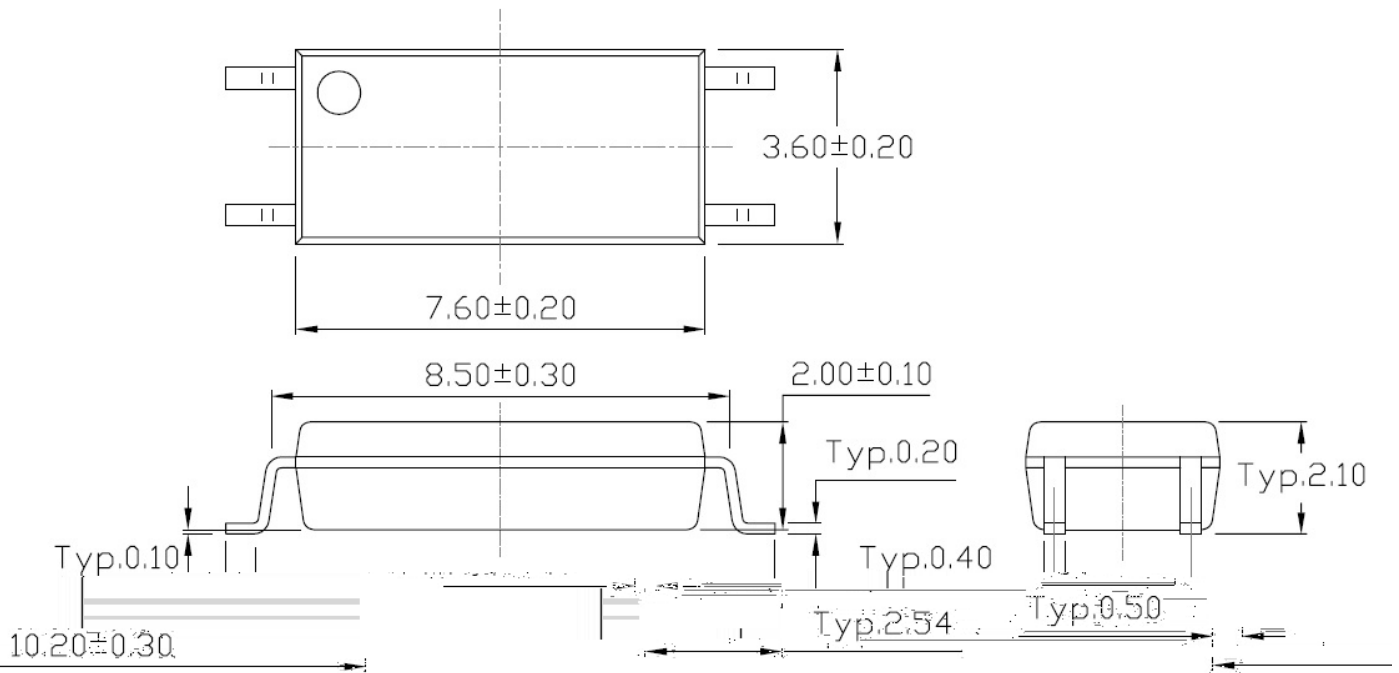


Fig. 14 Test Circuit of Frequency

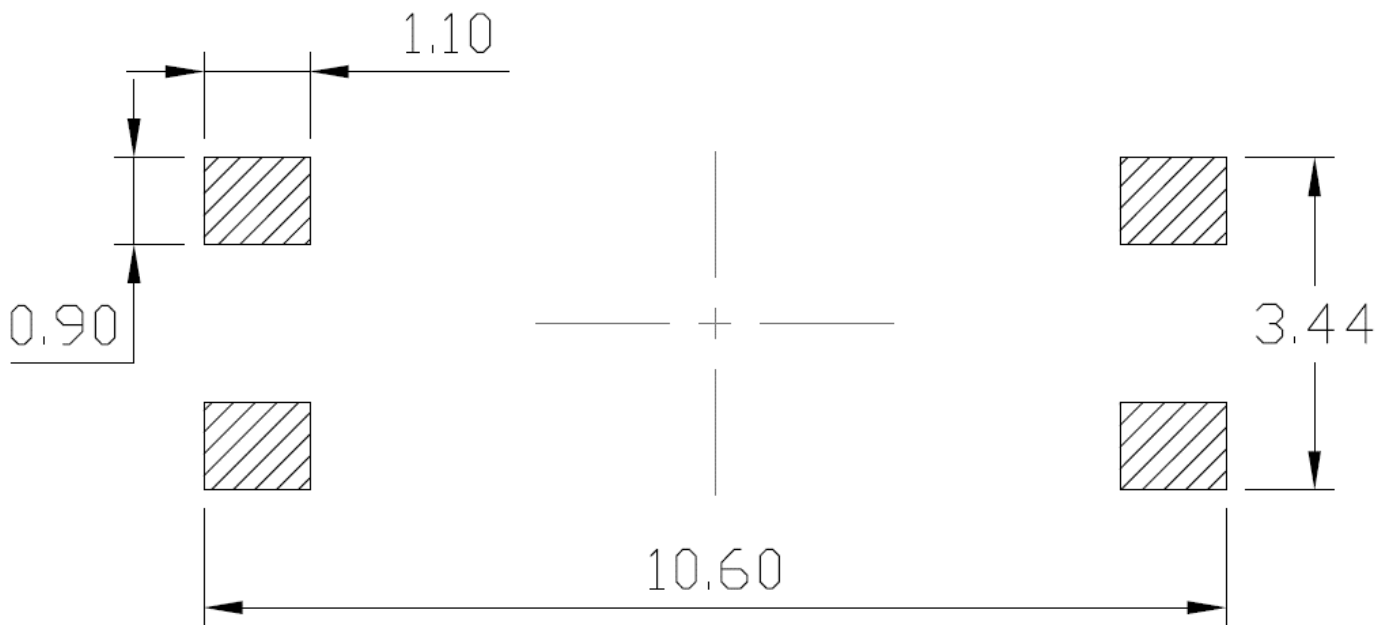




**PAC A ! E DIMENSIONS (Dimension\$ in mm & nle\$\$ other / i\$e \$tated=**



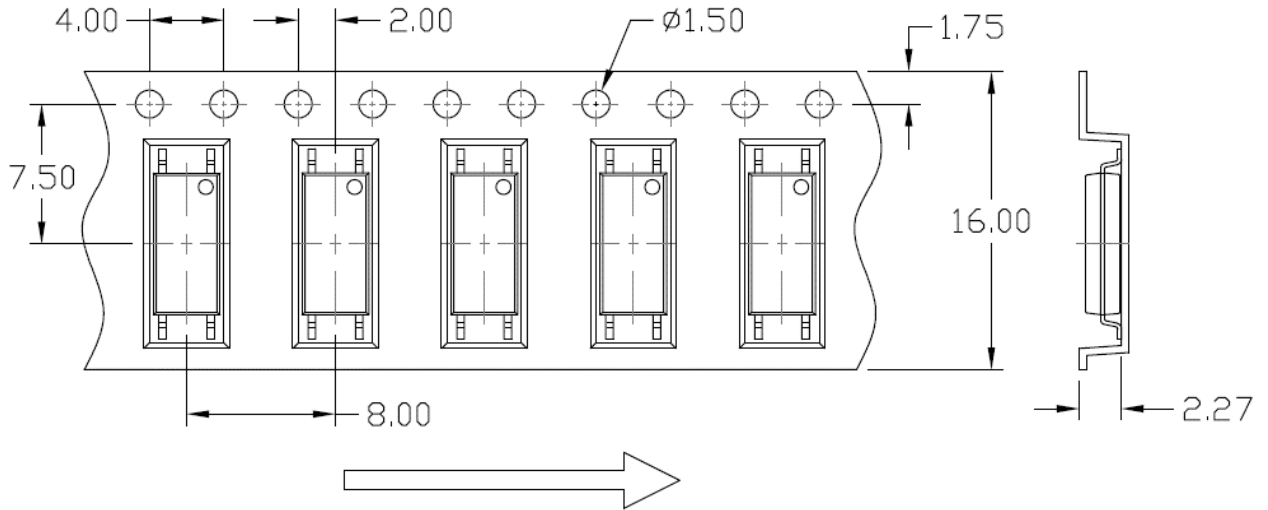
**) ECOMMENDED SO#DE ) MAS (Dimension\$ in mm & nle\$\$ other / i\$e \$tated=**



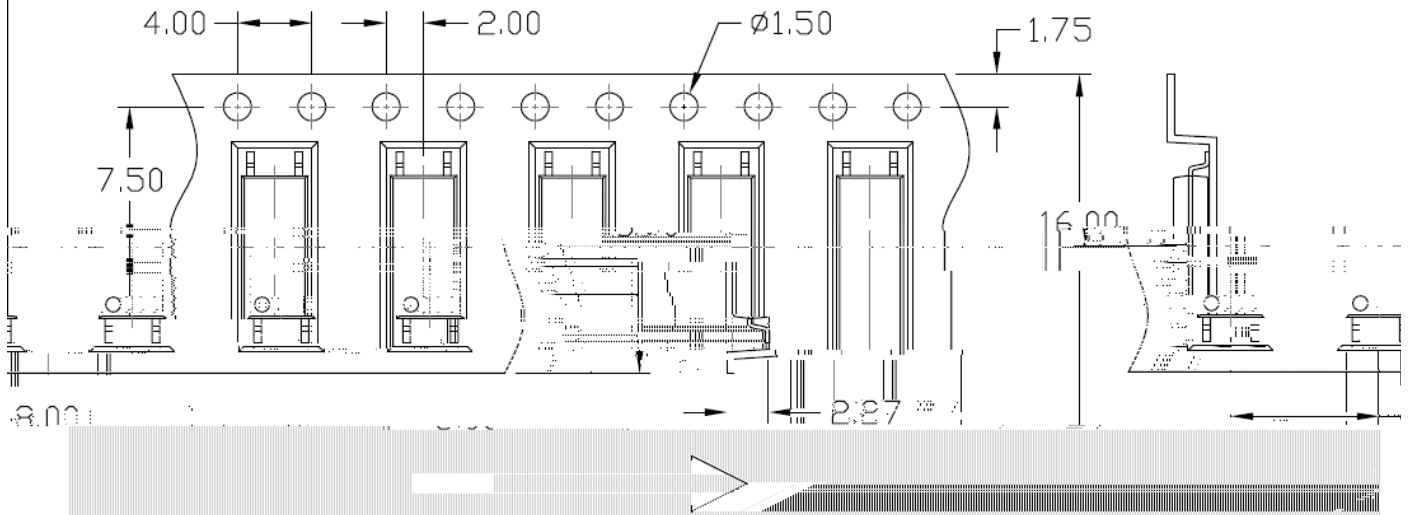


# CA ) IE ) TAPE SPECIFICATIONS (Dimension\$ in mm & nle\$\$ other / i\$e \$ stated=

## O%tion T1



## O%tion T2

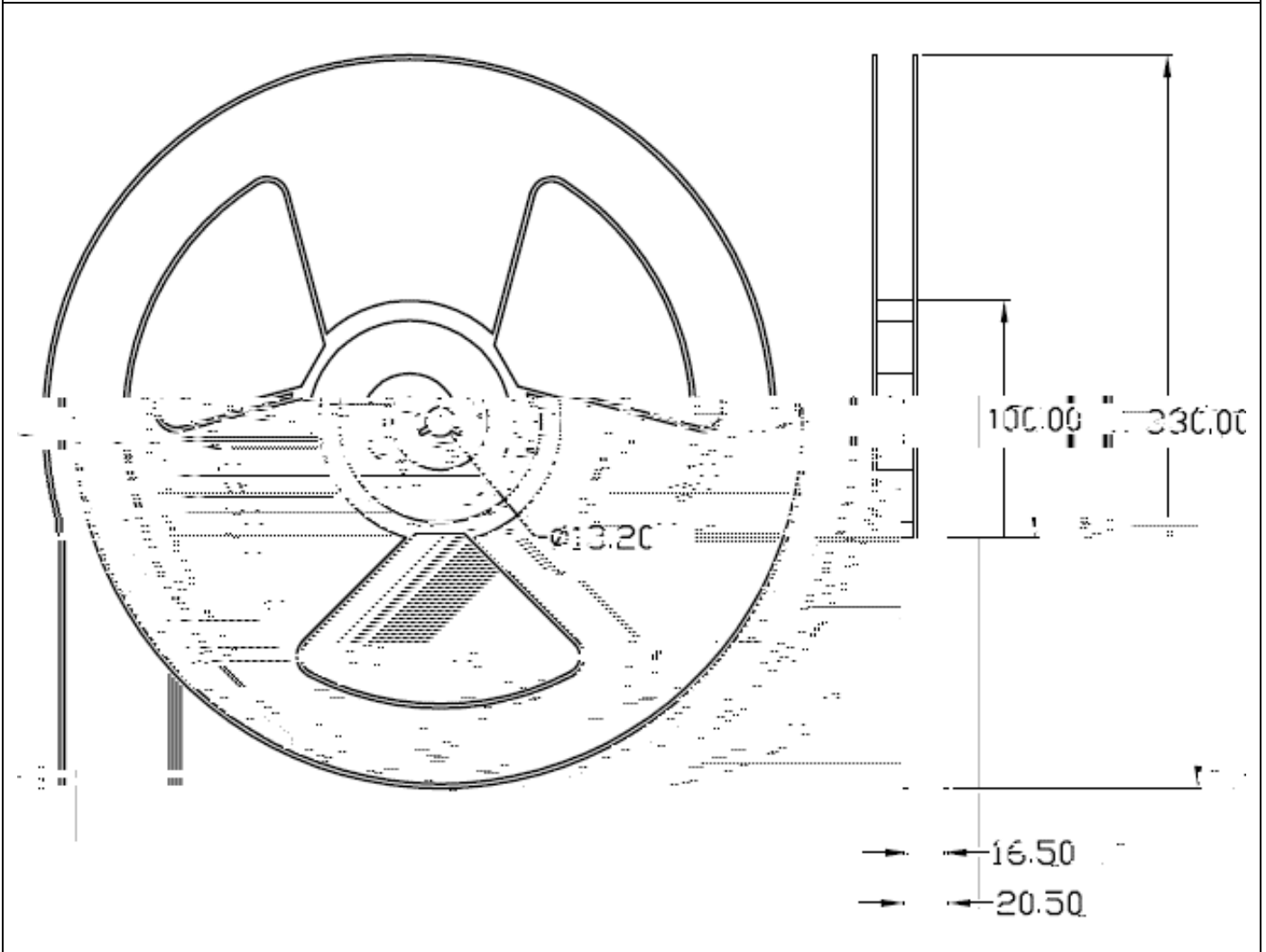






**) EE# SPECIFICATIONS (Dimension\$ in mm &nle\$\$ other / i\$e \$tated=**

**O%tion T1 > T2**





PRODUCT SPECIFICATIONS

Inner Size

L x W x H = 36cm x 36cm x 6.9cm



**O)DE)IN! AND MA) IN! INFO)MATION**

**MA) IN! INFO)MATION**



**TD**      @ Com%an< A11r.  
**1:1(**    @ Part N&m1er > )an2  
**-**        @ -DE O%tion  
**A**        @ Fi\$cal Aear  
**A**        @ Man&7act&rin. Code  
**B B**     @ Bor2 Bee2

**O)DE)IN! INFO)MATION**

**#A 'E# INFO)MATION**

**TD1:1 (CD=3! -**

TD : , ompany Abbr#  
 101X : \* an" 60J1J?J=J!J(J5J3J7J<8  
 K : Tape and \* eel Option 6T1JT?8  
 G : Green  
 ) : )D1 Option 6) or 4one8



**福建天电光电有限公司**  
FUJIAN LIGHTNING OPTOELECTRONIC CO., LTD.

Part No : XXXXXXXXXXXXX      Bin Code : X



Lot No : XXXXXXXXXXXX

Date Code : XXXX

Q'ty : XXXX pcs





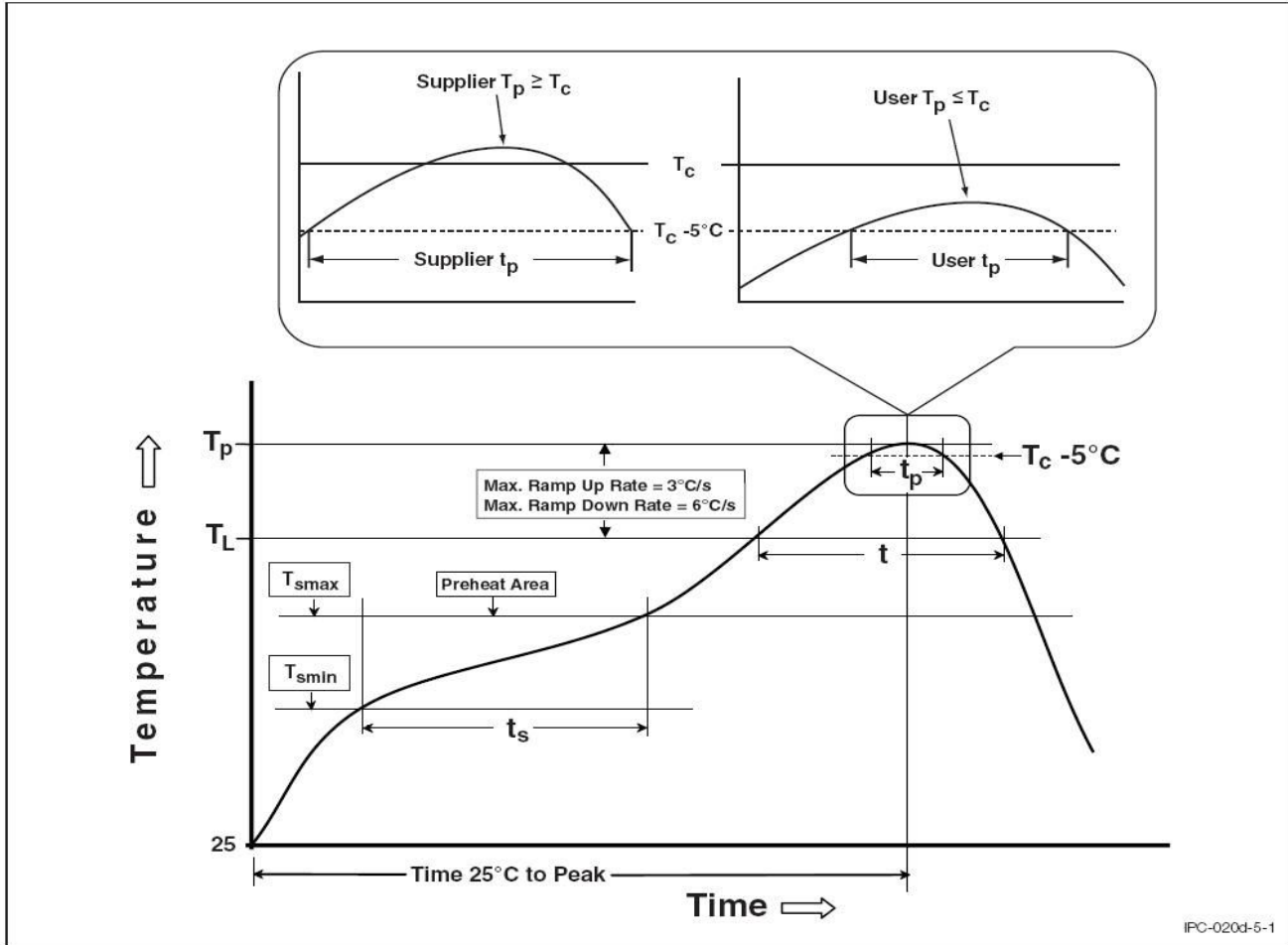
**PAC IN! E " ANTITA**

O%tion	E&antit<	E&antit< F Inner 1o?	E&antit< F O&ter 1o?
T1	=000 2nitsJ * eel	= * eelsJanner bo-	( Anner bo-JOuter bo- D ! (" 2nits
T?	=000 2nitsJ * eel	= * eelsJanner bo-	( Anner bo-JOuter bo- D ! (" 2nits



PROFILE INFORMATION

PROFILE OF THE



IPC-020d-5-1

Profile Feature	Sn3Pb Alloy Profile	Pb37Sn Alloy Profile
Temperature $\geq T_{smin}$	100	100
Temperature $\geq T_{smax}$	100	100
Time from $T_{smin}$ to $T_{smax}$	50.1 ± 0 seconds	50.1 ± 0 seconds
* ramp up rate $\geq T_L$ to $T_p$	≤ 3°C/s	≤ 3°C/s
Liquidus Temperature $T_L$	175°C	175°C
Time $T_L$ + maintained above $T_L$	50 : 100 seconds	50 : 100 seconds
Time to Peak	≤ 100 seconds	≤ 100 seconds
* ramp down rate $\geq T_L$ to $T_L$	≤ 6°C/s	≤ 6°C/s
Time to Peak	5 minutes max	7 minutes max



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